TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC165AFN

8-Bit Shift Register (P-IN, S-OUT)

The TC74HC165A is a high speed CMOS 8-BIT PARALLEL/SERIAL-IN, SERIAL-OUT SHIFT REGISTER fabricated with silicon gate C2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

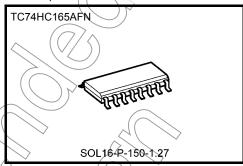
It consists of parallel-in or serial-in, serial-out 8-bit shift register with a gated clock inputs. When the SHIFT/ $\overline{\text{LOAD}}$ input is held high, the serial data input is enabled and the eight frip-frops perform serial shifting with each clock pulse.

When the SHIFT/ $\overline{\text{LOAD}}$ input is held low, the parallel data is loaded asynchronously into the register at positive going transition of the clock pulse.

The CK-INH input should be shifted high only when the CK input is held high.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.





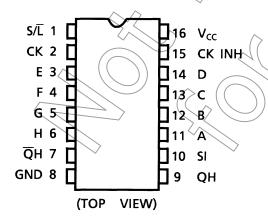
)vVeight ∕SOL16-P-150-1.27

);/0.13 g (typ.)

Features

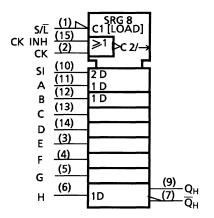
- High speed: $f_{max} = 56 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: ICC = $4 \mu A \text{ (max)}$ at Ta = 25 °C
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | IOH = IOL = 4 mA (min)
- Balanced propagation delays: tpLH = tpHL
- Wide operating voltage range: Vec(opr) = 2 to 6 V
- Pin and function compatible with 74LS165

Pin Assignment



2012-02-29

IEC Logic Symbol



Truth Table

			rnal puts	Out	puts			
SHIFT/ LOAD	CLOCK INH	CLOCK	SERIAL IN	PARALLEL A·····H	QA	QB	QH	QH
L	Х	Х	Х	a·····h	a	b	h	<u> </u>
Н	L		Н	X	¥	QAn	QGn	QGn
Н	L		L	x (QAn	QGn	QGn ,
Н		L	Н	X	H	QAn	QGn	QGn
Н		L	L	X	√ L	QĄń	QGn	QGn
Н	Х	Н	Х	X		No C	nange))
Н	Н	Х	Х	(x)		No Ch	nange	

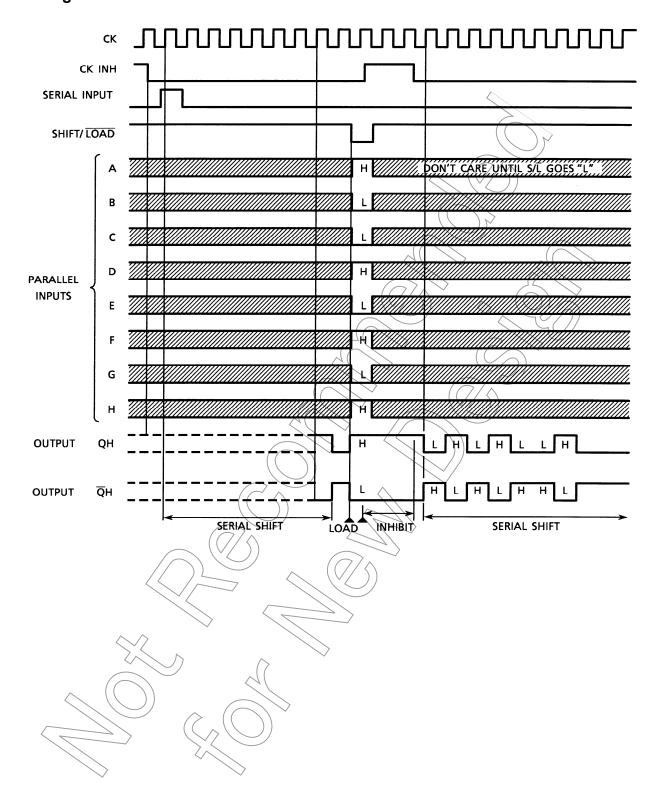
X: Don't care

a····h: The level of steady state input voltage at inputs A through H respectively

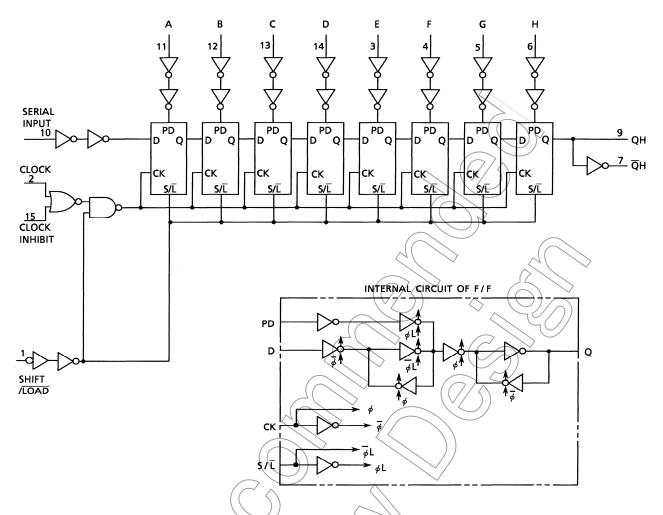
QAn~QGn: The level of QA~QG, respectively, before the most recent positive transition of the CK.



Timing Chart



System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	0.5 to 7	٧
DC input voltage	V _{IN}	=0.5 to V _{CC} + 0.5	٧
DC output voltage	Vou	-0.5 to V _{CC} + 0.5	٧
Input diode current	I _{IK}	±20	mA
Output diode current	Ιøκ	±20	mA
DC output current	10UT	±25	mA
DC VCc/ground current	(tec)	±50	mA
Power dissipation	Pp	180	mW
Storage temperature	T _{stg}	–65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	< ∨
Operating temperature	T _{opr}	-40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	$\langle \ \rangle)$

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

				1/2	77		-	///-	n)=	
Characteristics	Symbol	-	Test Condition			Γa = 25°C			85°C	Unit
	•			VCC (A)	Min	Typ.	Max	Min	Max	
				2.0	1.50	_((\mathcal{I})	1.50	_	
High-level input voltage	V_{IH}		-	4.5	3.15	7/	\sim	3.15	_	V
				6.0	4.20	(\checkmark)) —	4.20	_	
			400	2.0		\backslash	0.50	_	0.50	
Low-level input voltage	V_{IL}			4.5	_ '))—	1.35	_	1.35	V
				6.0		/_	1.80	_	1.80	
				2.0	1.9	2.0	_	1.9		
	V _{OH}		I _{OH} = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage		F VIH OF VIL	_	6.0	5.9	6.0	_	5.9	_	V
			I _{OH} = -4 mA	4.5	4.18	4.31	_	4.13		
	//) \		$I_{OH} = -5.2 \text{ m/A}$	6.0	5.68	5.80	_	5.63	_	
				2.0		0.0	0.1	_	0.1	
		, (J _{OL} = 20 μA	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}		6.0	_	0.0	0.1	_	0.1	V
			I _{OL} = 4 mA	4.5		0.17	0.26	_	0.33	
			$I_{OL} = 5.2 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
Input leakage current)) I _{IN}	VIN=VCC of	GND	6.0		_	±0.1	_	±1.0	μА
Quiescent supply current	lcc	VIN = VCC or	GND	6.0	_	_	4.0	_	40.0	μА



Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol Test Condition			Ta =	25°C	Ta = -40 to 85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width	tu an		2.0		75	95	
(CK, CK INH)	t _{W (H)}	_	4.5 〈	_	15	19	ns
(CK, CK INH)	t _{W (L)}		6.0	λ	13	16	
Naincine con accident			2.0	(\subset)	75	95	
Minimum pulse width	t _{W (L)}	_	4.5		15	19	ns
(S/L)		<	6.0	$\langle \rangle$	13	16	
Minimum action time			2.0		75	95	
Minimum set-up time (PI- S/\overline{L})	ts	_	(4.5)	· —	15	19	ns
(PI- 5/L)			6.0	_	13	16	
Minimum action times		4	2.0	_	75	95	
Minimum set-up time	ts	-	4.5	-5	15	19	ns
(SI-CK, CK INH)		$(\langle // $	6.0	+(13	16	
Minimum set-up time			2.0	4	(75)	95	
(S/L -CK, CK INH)	ts		4.5		15	19	ns
(3/L -CK, CK INH)			6.0		13	16	
Minimum hold time			2.0		0	0	
(PI-S/L)	t _h		4.5) —	0	0	ns
(FI-3/L)			6.0	_	0	0	
Minimum hold time			2,0	_	0	0	
(SI-CK, CK INH)	t _h ((4.5	_	0	0	ns
(OF-OR, OR INT)			√ 6.0	_	0	0	
Minimum hold time			2.0	_	0	0	
(S/L̄-CK, CK INH)	th		4.5	_	0	0	ns
(3/2-010, 010 1101)	$(\langle // $		6.0		0	0	
Minimum removal time		~ (0)/^	2.0	_	75	95	
(CK INH-CK)	trem		4.5	_	15	19	ns
(CK-CK INH)	_		6.0	_	13	16	
			2.0	_	7	6	
Clock frequency	f	──── -	4.5	_	30	24	MHz
	$\langle \rangle$	•	6.0	_	41	28	

AC Characteristics (C_L = 15 pE, $V_{CC} \Rightarrow 5$ V, Ta = 25°C, input: $t_r = t_f = 6$ ns)

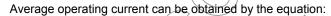
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH}	_	_	4	8	ns
Propagation delay time	t _{pLH}	_		15	25	ns
(CK, CK INH-QH, $\overline{Q}H$)	t _{pHL}	_		2	20	113
Propagation delay time	t _{pLH}			15	25	ns
$(S/\overline{L}-QH, \overline{Q}H)$	t _{pHL}	_		13	23	113
Propagation delay time	t _{pLH}			14	26	ns
(H-QH, QH)	t _{pHL}	_		14	20	115
Maximum clock frequency	f _{max}	_	35	56	_	MHz

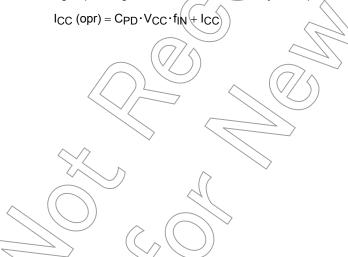


AC Characteristics (C $_{L}=50\ \text{pF},$ input: $t_{r}=t_{f}=6\ \text{ns})$

Characteristics	Test Condition			Ta = 25°C		Ta –40 to	Unit		
	-		V _{CC} (V)	Min	Тур.	Max	Min	Max	
	4		2.0	_	25	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8	15	_	19	ns
	t _{THL}		6.0		7	13	_	16	
Propagation delay time	t		2.0		55	150	1	190	
(CK, CK INH-QH, QH)	t _{pLH}	_	4.5	_	18	30_) —	38	ns
(CIX, CIX IIVII-QII, QII)	t _{pHL}		6.0	<	15	26	_	33	
Propagation delay time	t		2.0	_/	60	165	_	205	
(S/L -QH, QH)	t _{pLH}	_	4.5	-(19	19 33	_	41	ns
(3/L-QII, QII)	t _{pHL}		6.0	-	16)	28	_	35	
Propagation delay time	t _{pHL}		2.0		52	135	\mathcal{I}	170	
(H-QH, QH)		_	4.5	17		27	X+	34	ns
(11-011, 011)			6.0	\sim	14	23	7-/	> 29	
			2.0) }	14	7	6) —	
Maximum clock frequency	f _{max}		4.5	30	46	7	24/	_	MHz
,			6.0	41	65	(28	_	
Input capacitance	C _{IN}	- (_	5	_10/	_	10	pF
Power dissipation	C _{PD}		\langle	((Z55)				nE.
capacitance	(Note)				\$				pF

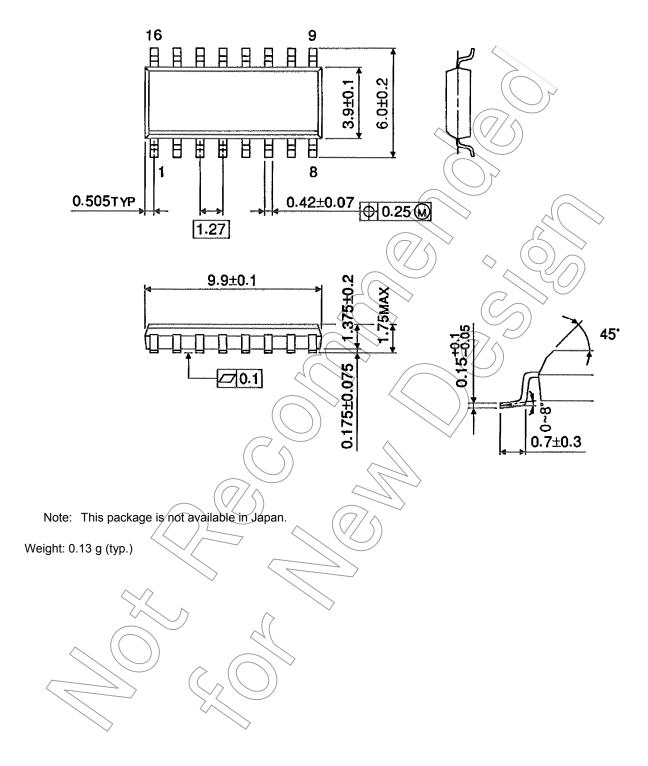
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.





Package Dimensions (Note)

SOL16-P-150-1.27 Unit: mm



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